

1. A method to heat-treat a substrate, comprising the steps of:

2. A method to heat-treat a substrate coated with a coating solution which oxidizes at high temperatures, said method comprising the steps of:

3. The method as set forth in claim 2,  
wherein said step (c) returns the treatment atmosphere to  
that with the original oxygen concentration after the passage of  
a predetermined time from the completion of said heat treatment.

5. The method as set forth in claim 2,  
wherein said step (a) replaces the treatment atmosphere with  
inert gas when the temperature is low.

6. The method as set forth in claim 2,  
wherein said step (c) exposes the substrate to the air after  
the passage of a predetermined time from the completion of said  
heat treatment.

7. The method as set forth in claim 2,

8. ~~The method as set forth in claim 2,~~  
~~wherein said step (c) exposes the substrate to the air when~~  
~~the temperature of the substrate becomes lower than a predetermined~~  
~~value.~~

10. The apparatus as set forth in claim 9, further comprising:  
support pins appearing and disappearing from / into a surface  
of said holding and heating member for supporting the substrate  
apart from the surface of said holding and heating member when  
appearing and for mounting the substrate on the surface of said  
holding and heating member when disappearing, and

wherein said replacing means replaces the atmosphere in said treatment chamber with inert gas in a state that the substrate is supported by said support pins;

wherein said heat-treating means heat-treats the substrate, which is mounted on the surface of said holding and heating member as a result of said support pins disappearing, in the atmosphere which is replaced with the inert gas by said replacing means; and

wherein said means for exposing separates the substrate from the surface of said holding and heating member by projecting said support pins after completing the heat treatment and opens the lid body to expose the inside of said treatment chamber to the air after the passage of a predetermined time.

11. The apparatus as set forth in claim 9,  
wherein said replacing means includes a means for blowing inert gas into said treatment chamber.

12. The apparatus as set forth in claim 11, further comprising:  
a means for controlling the blowout of the inert gas by the blowing means corresponding to the passage of treatment time.

13. A heat treatment apparatus, comprising:  
a treatment chamber;  
a holding member provided in said treatment chamber for holding a substrate coated with an organic coating solution;  
a means for replacing an atmosphere in said treatment chamber with inert gas;  
a means for heat-treating the substrate held by said holding member in the atmosphere which is replaced with the inert gas by said replacing means;

a means for measuring the temperature of the substrate to be heat-treated; and

a means for exposing the inside of said treatment chamber to the air when the temperature of the substrate becomes lower than a predetermined value after completing the heat treatment.

14. A treatment system, comprising:  
a treatment chamber;

a holding member provided in said treatment chamber for holding a substrate coated with an organic coating solution;

a means for replacing an atmosphere in said treatment chamber with inert gas;

a means for heat-treating the substrate held by said holding member in the atmosphere which is replaced with the inert gas by

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said replacing means;

a means for exposing the inside of said treatment chamber to the air after the passage of a predetermined time from the completion of the heat treatment; and

a carrying apparatus disposed in said treatment chamber for carrying the substrate in / out, and

wherein said carrying apparatus includes a holding and cooling plate for holding and cooling the substrate, and adjusting and supporting pins disposed adjustably in height on the holding and cooling plate for supporting the substrate to be apart from the holding and cooling plate.

15. A treatment system, comprising:

a treatment chamber;

a heat treatment section provided in said treatment chamber for heat-treating a substrate;

a carrying apparatus provided in said treatment chamber for carrying the substrate into / out of said heat treatment section; and

a means for replacing an atmosphere in said treatment chamber with cooled inert gas.

16. The treatment system as set forth in claim 15,

wherein said replacing means replaces the atmosphere in said treatment chamber with the cooled inert gas when said carrying apparatus carries the substrate out of said heat treatment section.

17. A treatment system, comprising:

a casing;

a heating and mounting table provided in said casing for heating the mounted substrate to a predetermined temperature;

a hoisting and lowering member provided at a heating and mounting table and vertically moving with holding the substrate; and

a cooling and mounting table provided in said casing for receiving the substrate which is supported by said hoisting and lowering member and for cooling the received substrate to a

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18. The treatment system as set forth in claim 17,  
wherein said casing includes a substrate carrying-in  
aperture for carrying the substrate in and a substrate carrying-out  
aperture for carrying the substrate out;

wherein said cooling and mounting table moves to a position where the substrate is carried out from the substrate carrying-out aperture.

wherein said heating and mounting table mounts thereon the substrate which is carried in from the substrate carrying-in/out aperture; and

wherein said cooling and mounting table moves to a position where the substrate is carried out from the substrate carrying-in/out aperture.

20. The treatment system as set forth in claim 17,  
wherein said cooling and mounting table includes a notch  
section which is free from touching said hoisting and lowering  
member.

21. The treatment system as set forth in claim 17, further comprising:

a cover for covering said heating and mounting table in said casing.

22. The treatment system as set forth in claim 17, further comprising:

a member disposed between said heating and mounting table and said cooling and mounting table for insulating a thermal

atmosphere.

23. The treatment system as set forth in claim 17,  
wherein said cooling and mounting table includes therein  
a channel in which a temperature-controlled fluid flows.

24. The treatment system as set forth in claim 17,  
wherein said cooling and mounting table is provided with  
Peltier elements.

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